



IN THE UNITED STATES  
PATENT AND TRADEMARK OFFICE

**PATENT APPLICATION**

*[Handwritten signature]*  
#8 2/15/02

Applicant: **Wu, et al.**  
Serial No.: **09/583,512**  
Examiner: **Rose, Robert**

Case: **4658/CMP/CMP/RKK**  
Filed: **May 31, 2000**  
Group Art Unit: **3723**

Title: **SYSTEM AND METHOD FOR CHEMICAL MECHANICAL  
PLANARIZATION**

ASSISTANT COMMISSIONER FOR PATENTS  
Washington, DC 20231

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Disclosure Statement Under 37 C.F.R. §1.97(C)(2)

Pursuant to 37 C.F.R. §1.97(C), the documents (copies enclosed) listed on Form PTO-1449, submitted herewith, are disclosed. Check No. 8402 in the amount of \$180.00 is attached as payment for the fee set forth in §1.17(p). Under Rule 37 C.F.R. §1.98(a), the Applicants submit that no specific comments are necessary for any of the cited foreign language publications having an enclosed English language translation or abstract.

Respectfully submitted,

Jan 18, 2002  
Date

By: *[Signature]*  
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CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited on 1-18-02 with the United States Postal Service as first-class mail, with sufficient postage, in an envelope addressed to the Assistant Commissioner for Patents, Washington, DC 20231.

Allyson M. DeVesty  
Signature

1-18-02  
Date of signature